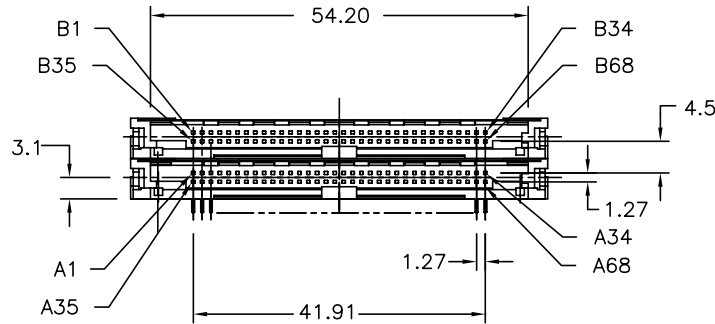
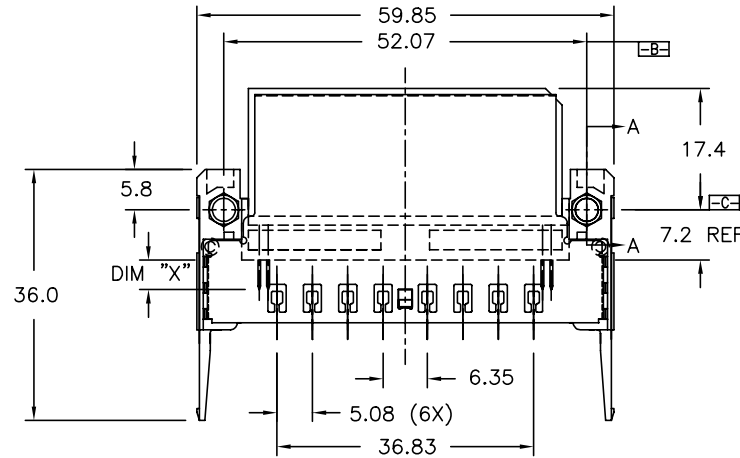
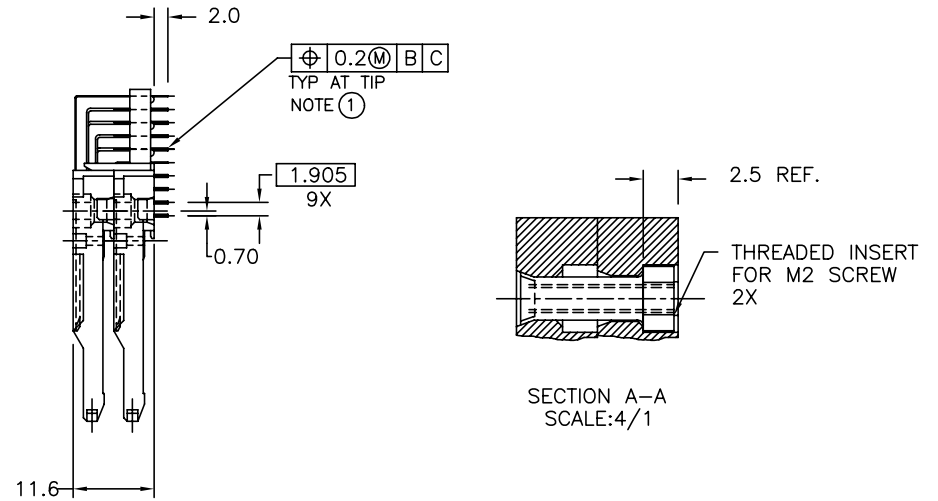


| PRODUCT NO. | DIM "X" | | |
|--------------|----------|---------|----------------------|
| 71257-0000 | 4.25±0.1 | 3.5±0.1 | 5±0.1 |
| 71257-0000LF | OTHERS | 36,67 | 1,17,34, 35,51,68 |

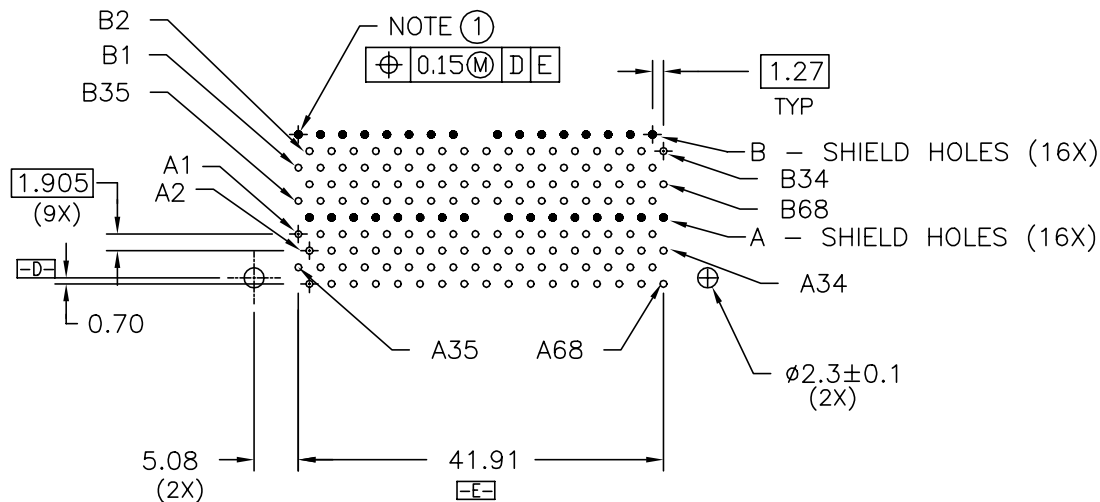


NOTES:

- TRUE POSITION IS A FREE GRID TO THE PIN PATTERN ITSELF.
- MATERIAL:
PLASTIC: HIGH TEMPERATURE THERMOPLASTIC UL94V-0 BLACK
PIN: COPPER ALLOY
- FINISH (PIN):
UNDER PLATING: 0.5 µM MIN. Ni
CONTACT AREA: 0.076 µm MIN. GOLD
SOLDER AREA: 2.5 µM MIN. Sn-Pb
LEAD FREE SOLDER TAIL PLATING 2µm (80u") MIN. MATTE TIN
OVER 1.27µm (50u") MIN. NICKEL UNDERPLATE.
- RECOMMENDED SCREW TORQUE: 1.0 TO 1.5 MAX in-lbs.
(1.2-1.7 cm-kgs). RECOMMENDED HOLD DOWN: 2mm
SCREWS (95121-002) AND HEX NUTS (92869-001).
- IF LEAD FREE PART NUMBER, THE HOUSING WILL WITHSTAND EXPOSURE TO 260° C
PEAK TEMPERATURE FOR 10 SECONDS IN A WAVE SOLDER APPLICATION WITH A
1.60mm MIN. THICK CIRCUIT BOARD.
- PACKAGING SPECIFICATION: GS-14-415.
PACKAGING OF LEAD FREE PRODUCTS MEETS LABELING AND PACKAGING
SPECIFICATION GS-14-920.
- LEAD FREE PRODUCTS MEET EUROPEAN UNION DIRECTIVES AND OTHER COUNTRY
REGULATIONS AS DESCRIBED IN GS-22-008.
- PRODUCT SPEC: 110-263



| | | | | |
|---------------------------|--------------------|---------------------------------------|------------------|--|
| mat'l. code | surface ISO1302 | tolerance ISO406 ISO1101 | projection MM | product family PCMCIA |
| ltr ecn nodr | date | tolerances unless otherwise specified | scale 1:1 | title |
| A V60110 RHG 01/04/96 | angle | 0.X±0.3 | MM | RIGHT ANGLE DOUBLE DECK CARDBUS HEADER ASSEMBLY |
| B V70388 RHG 05/22/97 | 0°±x' | 0.XX±0.13 | | |
| C V12254 TFG 09/24/01 | | 0.XXX±0.05 | | |
| D V12254 HTB 10/08/03 | dr | D.SHEAFFER 08/11/95 | FCI | dwg no |
| E N05-0057 DAI 03/30/05 | enr | D.BRANN 08/11/95 | | sheet 1 of 2 |
| F BX-N-007944 ZK 11/01/11 | chr | D.BRANN 08/11/95 | | size |
| G BX-N-011402 ZK 04/23/12 | appd | D.BRANN 08/11/95 | | A4 |
| sheet | revision | G | | type |
| index | sheet | 1 2 | | Product Customer Drawing |



NOTES:

- ① RECOMMENDED DIAMETER IS $\phi 1.0$. FOR PROCESSES USING PASTE REFLOW, HOLE MAY BE AS SMALL AS $\phi 0.79$.
- 2 ALL TOLERANCES ± 0.15 UNLESS NOTED.

| | | | | |
|-------------------|---------------------------------------|---------------------|------------|-------------------------------|
| mat'l. code | surface | tolerance | projection | product family |
| | ISO1302 | ISO406 ISO1101 | | PCMCIA |
| ltr ecn nodr date | tolerances unless otherwise specified | | MM | RIGHT ANGLE DOUBLE DECK |
| g | angle | 0.X \pm 0.3 | scale 1:1 | CARDBUS HEADER ASSEMBLY |
| | | 0.XX \pm 0.13 | | |
| | 0'±x' | 0.XXX \pm 0.05 | | |
| | dr | D.SHEAFFER 08/11/95 | | dwg no |
| | enr | D.BRANN 08/11/95 | | sheet 2 of 2 |
| | chr | D.BRANN 08/11/95 | | size |
| | appd | D.BRANN 08/11/95 | | A4 |
| sheet index | revision sheet | | | type Product Customer Drawing |